

| L Number | Hits | Search Text | DB | Time stamp |
|----------|-------|--|---|------------------|
| 541 | 1 | ("5980683").PN. | USPAT | 2002/03/21 14:55 |
| 542 | 33137 | (thermoplastic or thermosetting) with (epoxy or polyimide or bt) | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB | 2002/03/21 15:10 |
| 543 | 2688 | ((thermoplastic or thermosetting) with (epoxy or polyimide or bt)) and chip | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB | 2002/03/21 15:04 |
| 544 | 964 | ((thermoplastic or thermosetting) with (epoxy or polyimide or bt)) and 257/\$.ccls. | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB | 2002/03/21 15:10 |
| 546 | 129 | (thermoplastic or thermosetting) with bt | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB | 2002/03/21 15:11 |
| 545 | 250 | ((((thermoplastic or thermosetting) with (epoxy or polyimide or bt)) and 257/\$.ccls.) and carrier | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB | 2002/03/21 15:23 |
| 547 | 1 | ("5980683").PN. | USPAT | 2002/03/21 15:22 |
| 548 | 120 | ((((thermoplastic or thermosetting) with (epoxy or polyimide or bt)) and 257/\$.ccls.) and carrier) and (rigid or strong or hard or reinforce) | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB | 2002/03/21 15:43 |
| 549 | 1 | ("5023202").PN. | USPAT | 2002/03/21 15:44 |
| 550 | 1 | ("5023202").PN. | USPAT | 2002/03/21 16:36 |
| 551 | 1 | ("5286679").PN. | USPAT | 2002/03/21 16:37 |